



#### 30V COMPLEMENTARY ENHANCEMENT MODE MOSFET H-BRIDGE

## **Product Summary**

Device	BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
N Channal	25mΩ @ V <sub>GS</sub> = 10V		6.0A
N-Channel	30V	$40m\Omega$ @ $V_{GS} = 4.5V$	4.6A
D. Okassa al	001/	$50m\Omega$ @ $V_{GS} = -10V$	-4.2A
P-Channel	-30V	$80m\Omega$ @ $V_{GS} = -4.5V$	-3.2A

#### **Description**

This new generation complementary MOSFET H-Bridge features low on-resistance achievable with low gate drive.

## **Applications**

- DC Motor Control
- DC-AC Inverters

#### **Features**

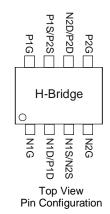
- 2 x N + 2 x P Channels in A SO-8 Package
- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMHC3025LSDQ)

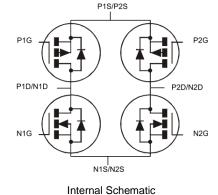
## **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 <sup>®</sup>
- Weight: 0.008 grams (Approximate)



Top View





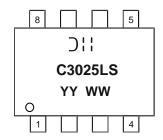
#### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMHC3025LSD-13	SO-8	2500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



⊃¦¦ = Manufacturer's Marking
 C3025LS = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 18 = 2018)
 WW = Week (01 to 53)



## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)		$P_{D}$	1.5	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	83	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{\theta JA}$	50		
Thermal Resistance, Junction to Case		R <sub>0</sub> JC	14.5		
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C	

## Maximum Ratings N-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage			V <sub>DSS</sub>	30	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Operitoring Project Operand (Alexa 5) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	6.0 4.8	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = 10V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	7.8 6.1	А
Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			I <sub>D</sub>	4.6 3.6	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = 4.5V	n Current (Note 5) V <sub>GS</sub> = 4.5V t < 10s		I <sub>D</sub>	6.1 4.8	А
Maximum Continuous Body Diode Forward Curren	t (Note 5)	I <sub>S</sub>	2.5	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	60	А

## **Maximum Ratings P-CHANNEL** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage	$V_{DSS}$	30	V		
Gate-Source Voltage			$V_{GSS}$	±20	V
Continuous Drain Current (Note 5) V 40V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	-4.2 -3.3	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = -10V	t < 10s	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	-5.4 -4.3	А
State T <sub>A</sub> = ±70°C		$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	-3.2 -2.5	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	-4.3 -3.3	Α
Maximum Continuous Body Diode Forward Current	I <sub>S</sub>	-2.5	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	-30	А

Note: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



## **Electrical Characteristics N-CHANNEL** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	0.5	μΑ	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±1	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	_	2	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance		l	19	25	mΩ	$V_{GS} = 10V, I_D = 5A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	26	40	11177	$V_{GS} = 4.5V, I_D = 4A$
Forward Transfer Admittance	Y <sub>fs</sub>	_	4	_	S	$V_{DS} = 5V$ , $I_D = 5A$
Diode Forward Voltage	V <sub>SD</sub>		0.70	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.7A
DYNAMIC CHARACTERISTICS (Note 7)						•
Input Capacitance	C <sub>iss</sub>	_	590	_		
Output Capacitance	Coss	_	122	_	pF	$V_{DS} = 15V$ , $V_{GS} = 0V$ , $f = 1MHz$
Reverse Transfer Capacitance	C <sub>rss</sub>	_	58	_		
Gate Resistance	Rq		1.5	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qq	_	5.4	_		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qq		11.7	_		V 45V L 70A
Gate-Source Charge	$Q_{gs}$		1.8	_	nC	$V_{DS} = 15V, I_D = 7.8A$
Gate-Drain Charge	$Q_{gd}$		2.1	_		
Turn-On Delay Time	t <sub>D(ON)</sub>		11.2	_		
Turn-On Rise Time	t <sub>R</sub>		15	_		$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	17.5	_	ns	$R_L = 2.4\Omega$ , $R_G = 1\Omega$
Turn-Off Fall Time	t <sub>F</sub>	_	8.7	_		
Reverse Recovery Time	t <sub>RR</sub>	_	18.3	_	ns	
Reverse Recovery Charge	Q <sub>RR</sub>	_	12	_	nC	$I_F = 12A$ , di/dt = 500A/ $\mu$ s

## Electrical Characteristics P-CHANNEL (@TA = +25°C, unless otherwise specified.)

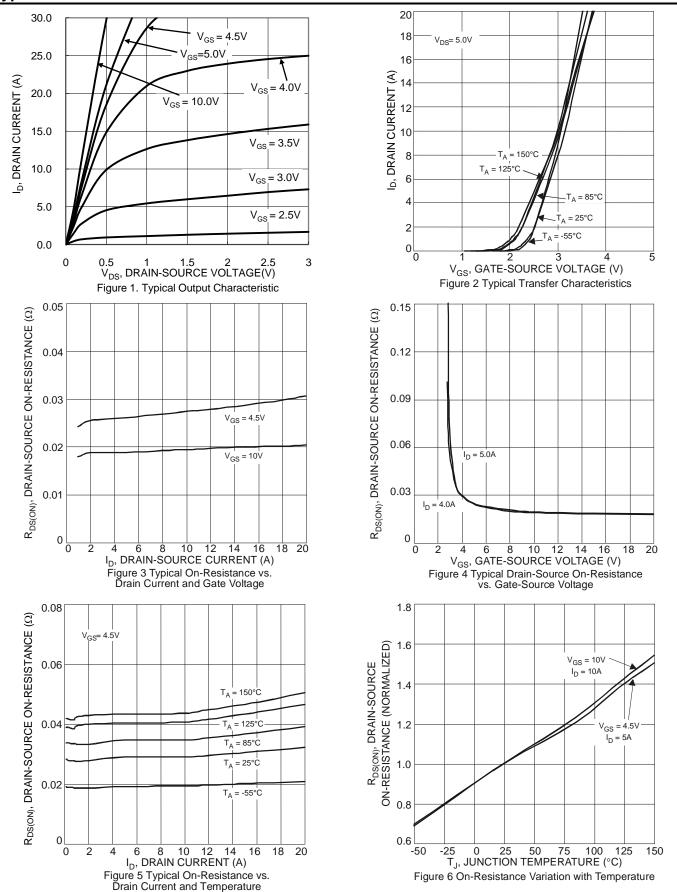
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	-0.5	μA	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±1	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1	_	-2	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance		l	43	50	mΩ	$V_{GS} = -10V, I_D = -5A$
Static Diani-Source On-Resistance	R <sub>DS(ON)</sub>		68	80	11122	$V_{GS} = -4.5V$ , $I_{D} = -4A$
Forward Transfer Admittance	Y <sub>fs</sub>	l	3.5	_	S	$V_{DS} = -5V, I_{D} = -5A$
Diode Forward Voltage	V <sub>SD</sub>	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1.7A$
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	C <sub>iss</sub>	_	631	_	pF	45)/ )/
Output Capacitance	Coss	_	137	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$ -f = 1MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	70	_	pF	-1 = TIVITIZ
Gate Resistance	Rg	_	10.8	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	5.5	_	nC	
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	11.4	_	nC	\
Gate-Source Charge	Q <sub>gs</sub>	_	1.8	_	nC	$V_{DS} = -15V, I_{D} = -6A$
Gate-Drain Charge	$Q_{gd}$	_	2.4	_	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	7.5	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	4.9	_	ns	$V_{DD} = -15V, V_{GS} = -10V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	28.2	_	ns	$R_G = 6\Omega$ , $I_D = -1A$
Turn-Off Fall Time	t <sub>F</sub>		13.5	_	ns	7
Reverse Recovery Time	t <sub>RR</sub>		15.1	_	ns	1 404 41/44 5004/
Reverse Recovery Charge	Q <sub>RR</sub>	_	15.3	_	nC	I <sub>F</sub> = -12A, di/dt = 500A/μs

Notes: 6. Short duration pulse test used to minimize self-heating effect.

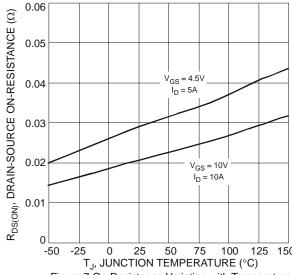
7. Guaranteed by design. Not subject to product testing.



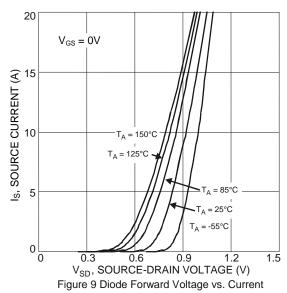
## **Typical Characteristics - N-CHANNEL**

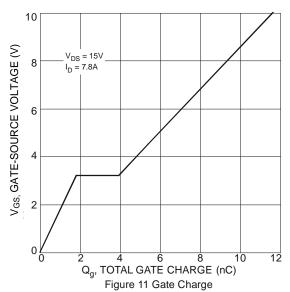












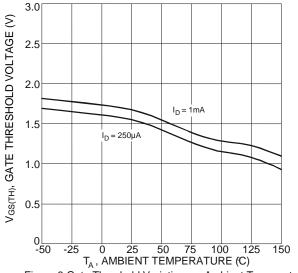
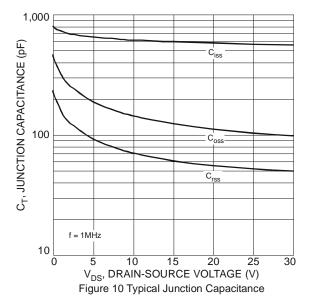
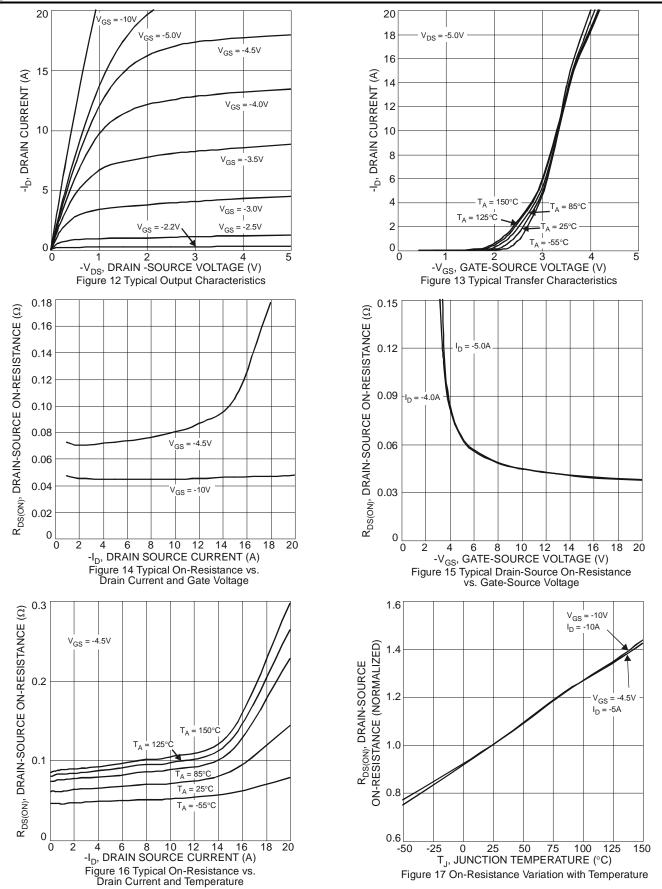


Figure 8 Gate Threshold Variation vs. Ambient Temperature





## Typical Characteristics - P-CHANNEL







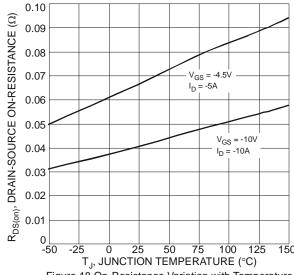
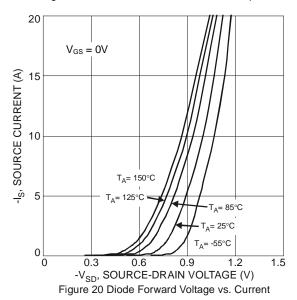
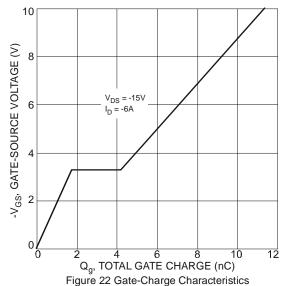


Figure 18 On-Resistance Variation with Temperature





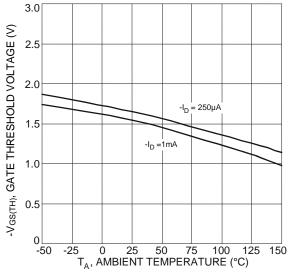
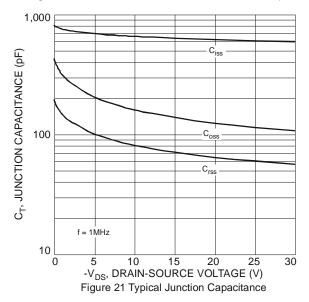


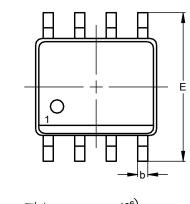
Figure 19 Gate Threshold Variation vs. Ambient Temperature

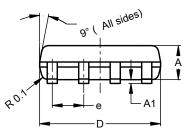


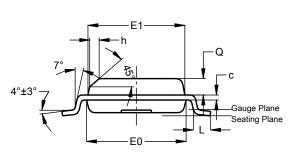


## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.







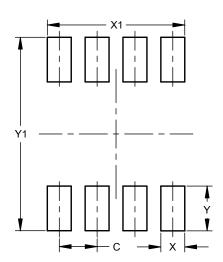
SO-8

SO-8							
Dim	Min	Max	Тур				
Α	1.40	1.50	1.45				
A1	0.10	0.20	0.15				
b	0.30	0.50	0.40				
С	0.15	0.25	0.20				
D	4.85	4.95	4.90				
Е	5.90	6.10	6.00				
E1	3.80	3.90	3.85				
E0	3.85	3.95	3.90				
е			1.27				
h	-		0.35				
Г	0.62	0.82	0.72				
Q	0.60	0.70	0.65				
All Dimensions in mm							

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.





<b>Dimensions</b>	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50



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